



WANSEMI
万芯半导体

WP2090S

Enhancement Mode N-Channel Power MOSFET

TO-252/NMOS/20V/ ± 12 V/0.7V/90A/3.2m Ω

Rev1.2



20V, 3.2mΩ, 90A, Single N-Channel

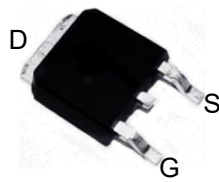
1.Features

- ◆ 20V MOSFET technology
- ◆ Low on-state resistance
- ◆ Fast switching
- ◆ $V_{GS} \pm 12V$

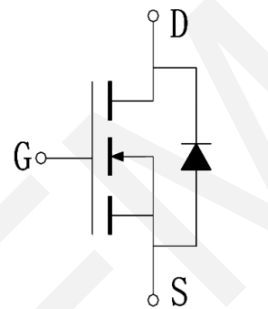
V_{DS}	$R_{DS(on)}$ Typ.	I_D Max.
20V	2.9mΩ @ 7.4V	90A
	3.2mΩ @ 4.5V	
	4.4mΩ @ 2.5V	

2.Applications

- ◆ Power Switching Application
- ◆ Load Switching



TO-252
Pin Description



Schematic Diagram

3.Package Marking and Ordering Information

Part Number	Grade	Marking	Package	PCS/Reel	PCS/CTN.
WP2090A	A	WP2090A	TO-252	2,500	25,000
WP2090S	B				

4.Absolute Max Ratings at $T_a=25^\circ C$ (Note1)

Parameter	Symbol	Maximum	Units
Drain to Source Voltage	V_{DSS}	20	V
Gate to Source Voltage	V_{GSS}	± 12	V
Drain Current (DC)	I_D	90	A
Drain Current (Pulse), $PW \leq 300\mu s$	I_{DP}	243	A
Total Dissipation	P_D	83	W
Avalanche Energy, Single Pulsed	E_{AS}	225	mJ
Junction Temperature	T_j	150	$^\circ C$
Storage Temperature	T_{stg}	-55 to +150	$^\circ C$

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

5. Thermal Resistance Ratings

Parameter	Symbol	Value	Unit
Junction to case	$R_{\theta JC}$	1.8	$^{\circ}C/W$

Note 2: When mounted on 1 inch square copper board $t \leq 10$ sec The value in any given application depends on the user's specific board design.

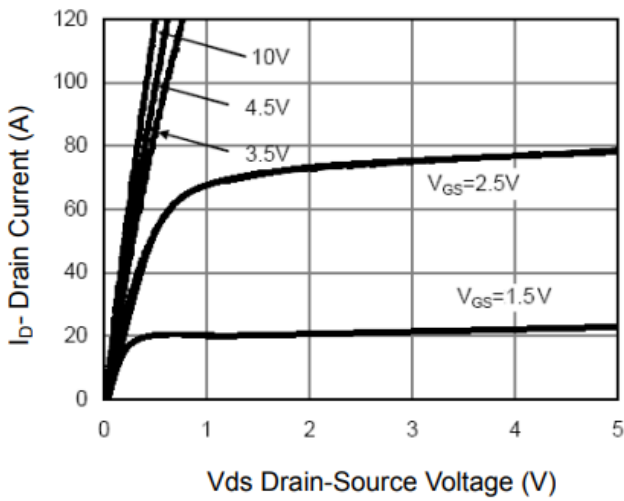
6. Electrical Characteristics at $T_a=25^{\circ}C$ (Note 3)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain to Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D = 250\mu A, V_{GS} = 0V$	20	-	-	V
Zero-Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 20V, V_{GS} = 0V$	-	-	1	μA
Gate to Source Leakage Current	I_{GSS}	$V_{GS} = \pm 12V, V_{DS} = 0V$	-	-	± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_{DS}=250\mu A$	0.5	0.7	1.2	V
Static Drain to Source On-State Resistance	$R_{DS(on)}$ Grade A	$I_D = 30A, V_{GS} = 7.4V$	-	2.9	3.7	$m\Omega$
		$I_D = 20A, V_{GS} = 4.5V$	-	3.2	3.9	$m\Omega$
		$I_D = 20A, V_{GS} = 2.5V$	-	4.4	6.1	$m\Omega$
Static Drain to Source On-State Resistance	$R_{DS(on)}$ Grade B	$I_D = 30A, V_{GS} = 7.4V$	-	3.0	-	$m\Omega$
		$I_D = 20A, V_{GS} = 4.5V$	-	3.4	-	$m\Omega$
		$I_D = 20A, V_{GS} = 2.5V$	-	5.5	-	$m\Omega$
Forward Transconductance	G_{FS}	$I_D = 20A, V_{DS} = 5V$	20	-	-	S
Input Capacitance	C_{iss}	$V_{GS}=0V,$	-	2016	-	pF
Output Capacitance	C_{oss}	$V_{DS}=10V,$	-	391	-	pF
Reverse Transfer Capacitance	C_{riss}	Frequency=1.0MHz	-	130	-	pF
Turn-ON Delay Time	$t_{d(on)}$	$V_{DD} = 10V, I_D = 20A,$ $V_{GS} = 10V,$ $R_{GEN} = 2.7\Omega$	-	6	-	ns
Rise Time	t_r		-	4	-	ns
Turn-OFF Delay Time	$t_{d(off)}$		-	31	-	ns
Fall Time	t_f		-	5	-	ns
Total Gate Charge	Q_g	$V_{DS} = 10V,$	-	15	-	nC
	Q_{gs}	$V_{GS} = 4.5V,$	-	3	-	nC
	Q_{gd}	$I_D = 20A$	-	4	-	nC
Diode Forward Voltage	V_{FSD}	$I_S = 20A, V_{GS} = 0$	-	-	1.2	V

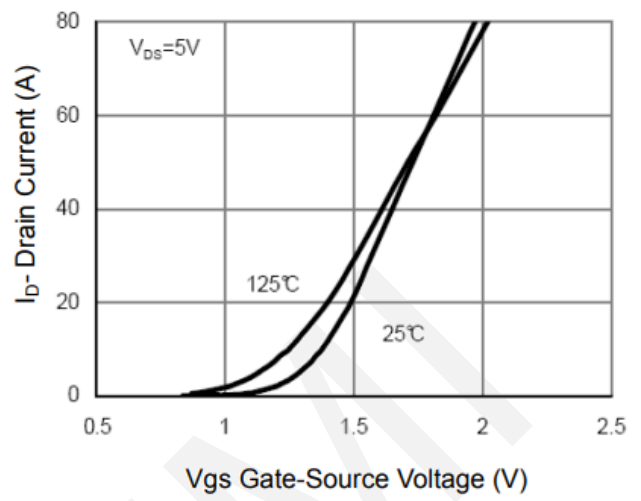
Note 3: Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



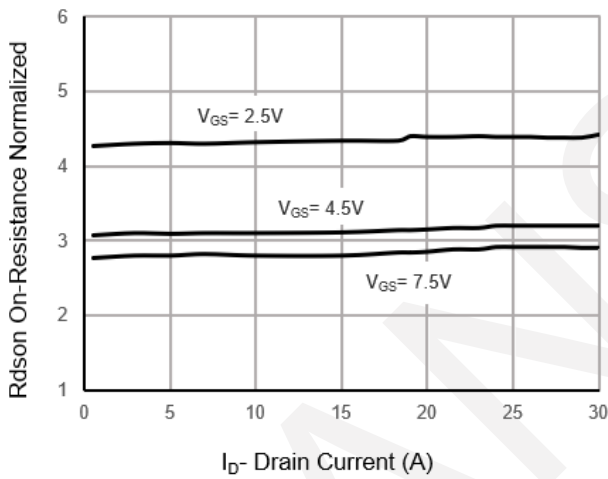
7. Typical electrical and thermal characteristics



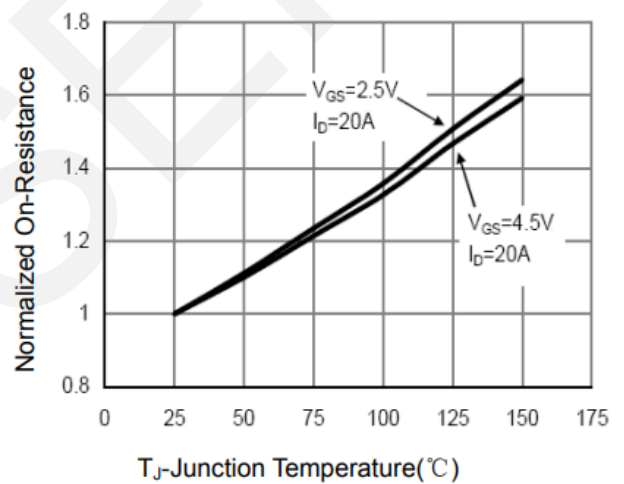
Output Characteristics



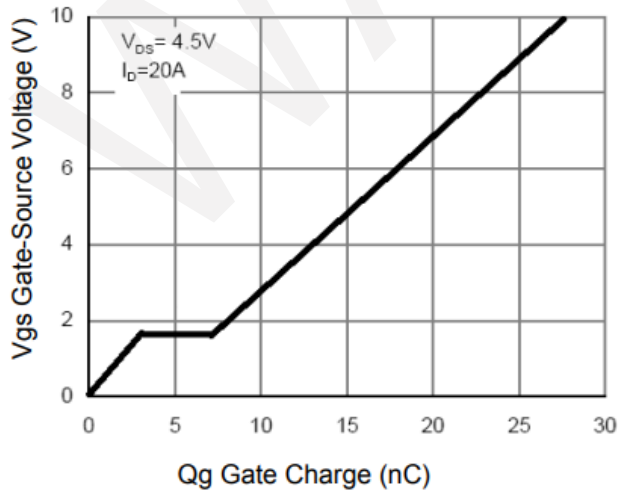
Transfer Characteristics



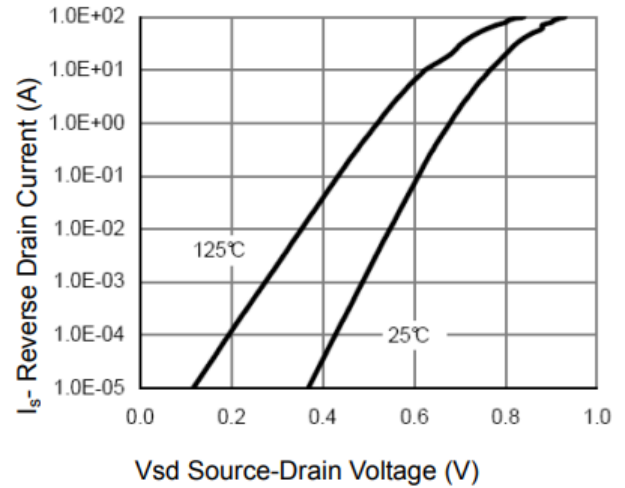
Rdson-Drain Current



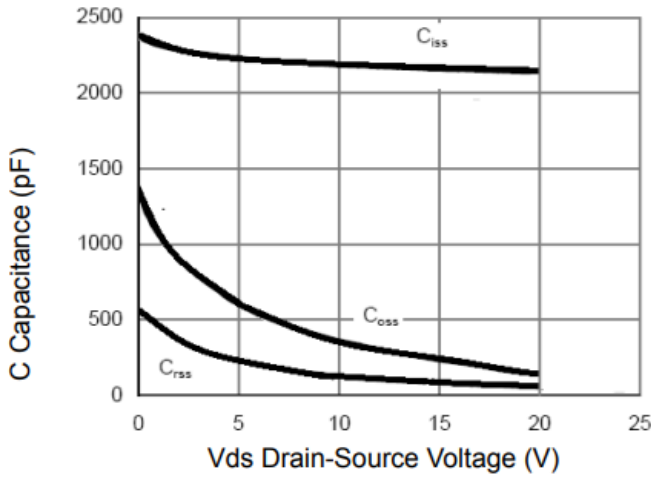
Rdson-Junction Temperature



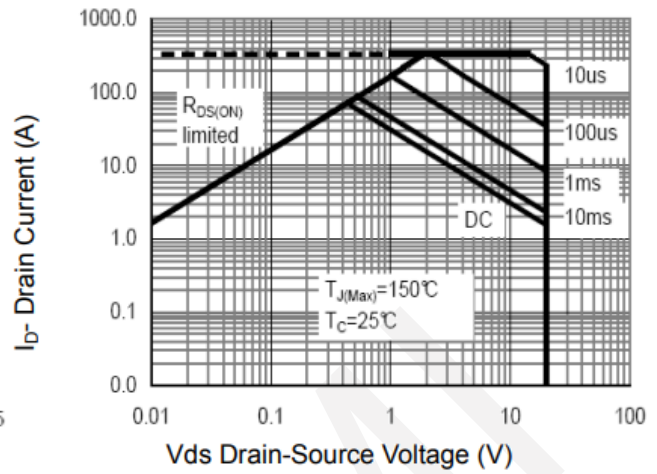
Gate Charge



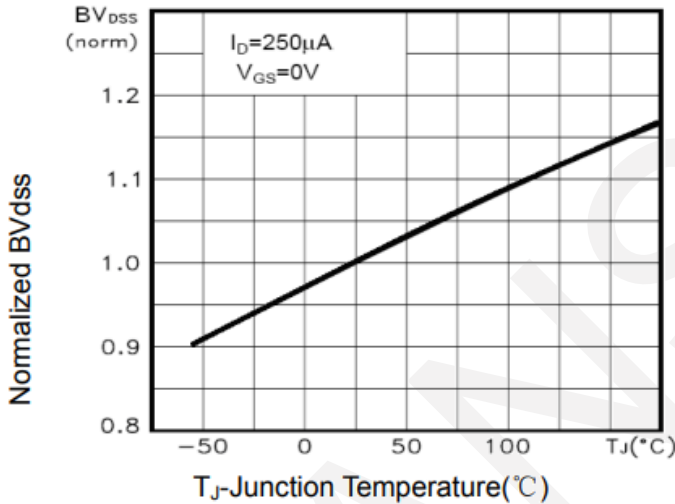
Source-Drain Diode Forward



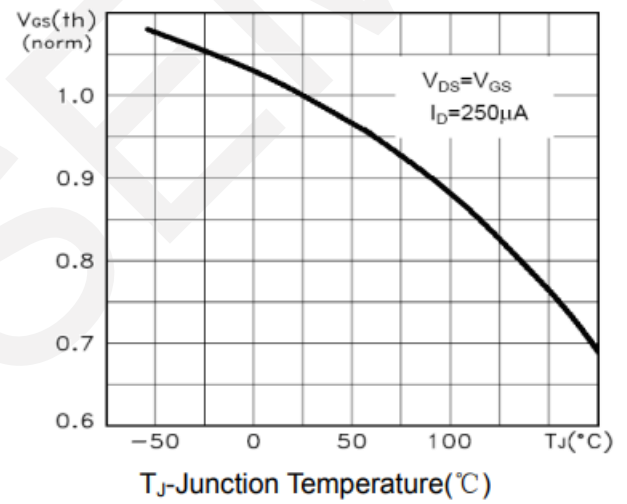
Capacitance vs Vds



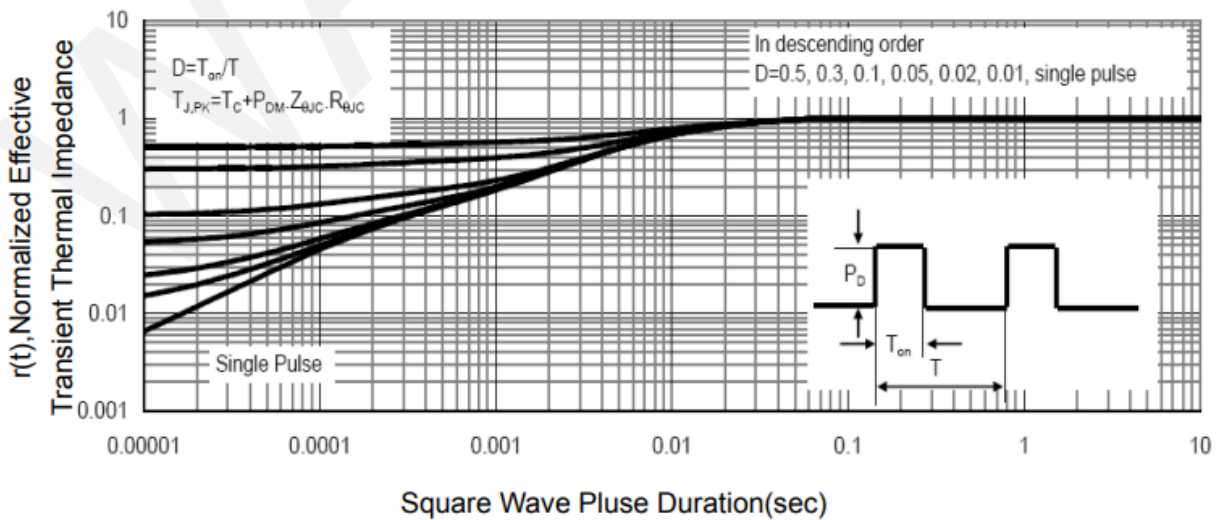
Safe Operation Area



BV_{DSS} vs Junction Temperature



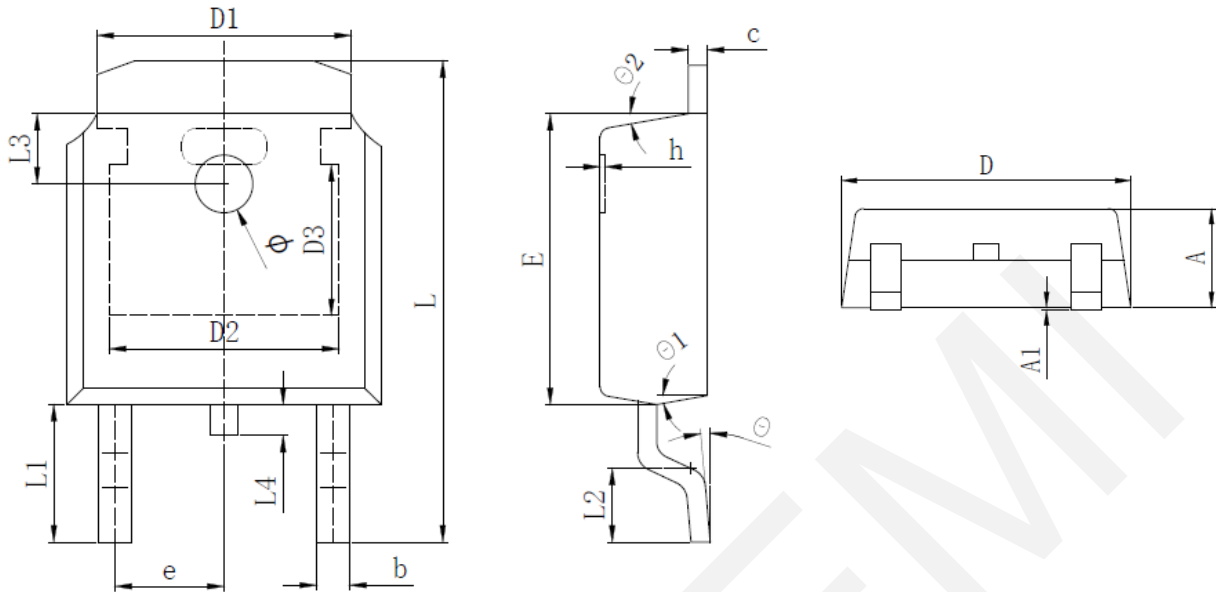
V_{GS(th)} vs Junction Temperature



Normalized Maximum Transient Thermal Impedance



8.Package Dimensions



SYMBOL	MILLIMETER		
	MIN	Typ.	MAX
A	2.200	2.300	2.400
A1	0.000		0.127
b	0.640	0.690	0.740
c(电镀后)	0.460	0.520	0.580
D	6.500	6.600	6.700
D1	5.334 REF		
D2	4.826 REF		
D3	3.166 REF		
E	6.000	6.100	6.200
e	2.286 TYP		
h	0.000	0.100	0.200
L	9.900	10.100	10.300
L1	2.888 REF		
L2	1.400	1.550	1.700
L3	1.600 REF		
L4	0.600	0.800	1.000
ϕ	1.100	1.200	1.300
θ	0°		8°
$\theta 1$	9° TYP		
$\theta 2$	9° TYP		

9. Important Notice

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